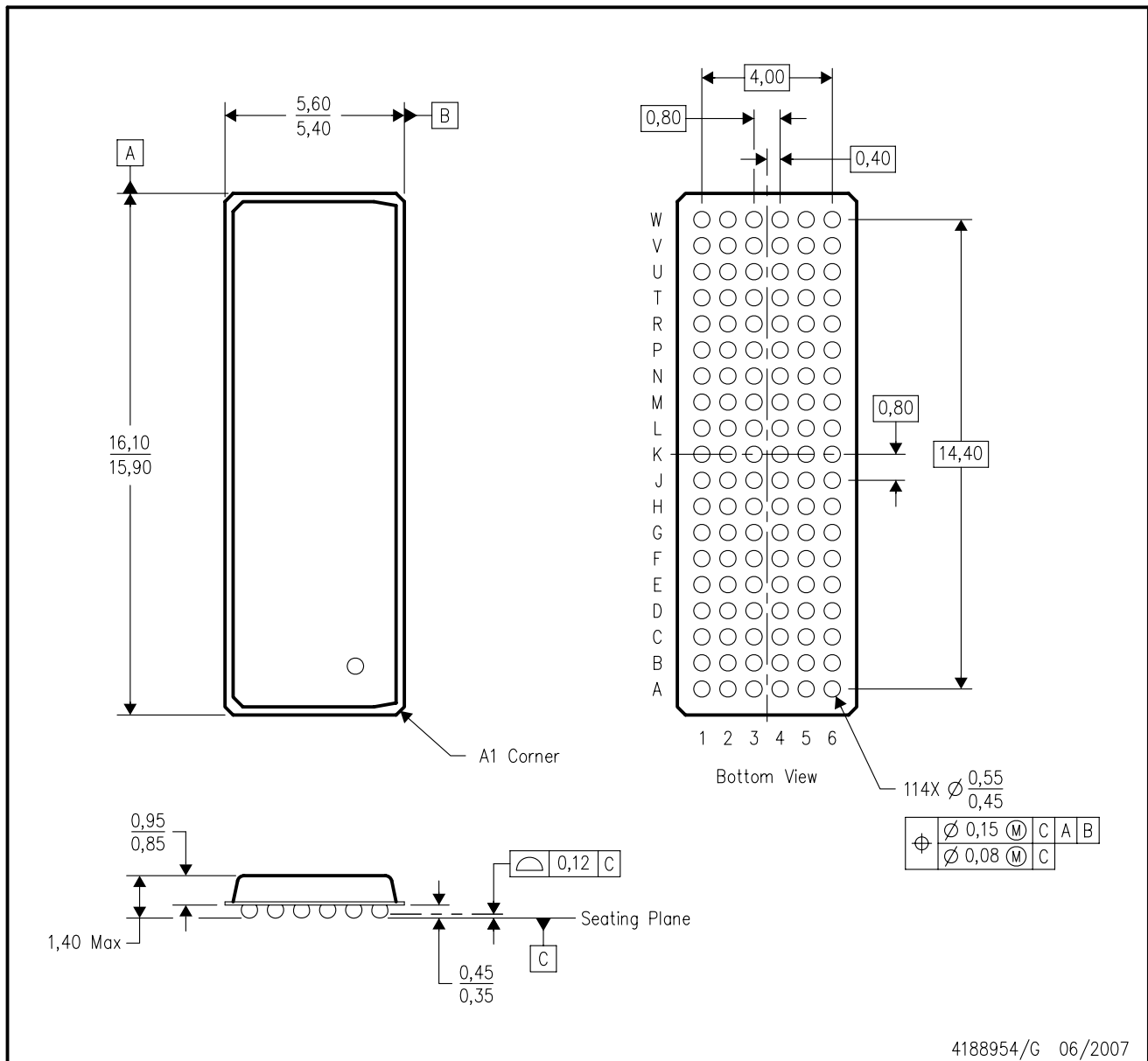


GKF (R-PBGA-N114)

PLASTIC BALL GRID ARRAY



- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
 - B. This drawing is subject to change without notice.
 - C. Falls within JEDEC MO-205 variation DC.
 - D. This package is tin-lead (SnPb). Refer to the 114 ZKF package (drawing 4204494) for lead-free.

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